

Title (en)  
OPENING DEVICE ON A SOLVENT PACKAGE

Title (de)  
ÖFFNUNGSVORRICHTUNG AN EINER FLIESSMITTELPACKUNG

Title (fr)  
SYSTEME D'OUVERTURE MONTE SUR UN EMBALLAGE DE SOLVANT

Publication  
**EP 0730553 A1 19960911 (DE)**

Application  
**EP 94930999 A 19941028**

Priority  
• DE 4340553 A 19931129  
• EP 9403554 W 19941028

Abstract (en)  
[origin: CA2176921A1] An opening device externally fitted to the top surface (1) of a package is described, with a lower part (3) which is provided with an approximately annular welding flange (4), and a sealing pan (6) moveable relative thereto, with the aid of which a sealing area (10) of the top surface can be torn away for opening. In order that the opening device can be manufactured more simply from a technical point of view and more inexpensively, and can be opened more easily and re-closed properly, it is provided according to the invention that the lower pan (3) is provided inside the welding flange (4) with an approximately annular tearing edge (16) narrowing downwards towards the sealing area (10), and the sealing pan (6) is configured approximately cup-shaped and its base (8) can be arranged inside the tearing edge (16) and is sealed by the sealing area (10).

IPC 1-7  
**B65D 51/22**; **B65D 75/58**

IPC 8 full level  
**B65D 33/36** (2006.01); **B65D 51/22** (2006.01); **B65D 75/58** (2006.01)

CPC (source: EP)  
**B65D 51/228** (2013.01); **B65D 75/5877** (2013.01); **B29C 65/08** (2013.01); **B29C 66/112** (2013.01); **B29C 66/131** (2013.01); **B29C 66/232** (2013.01); **B29C 66/24221** (2013.01); **B29C 66/30223** (2013.01); **B29C 66/47421** (2013.01); **B29L 2031/7128** (2013.01); **B65D 2251/0025** (2013.01); **B65D 2251/0096** (2013.01)

Citation (search report)  
See references of WO 9514622A1

Designated contracting state (EPC)  
AT BE CH DE DK ES FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)  
**DE 4340553 A1 19950601**; AU 7993194 A 19950613; CA 2176921 A1 19950601; EP 0730553 A1 19960911; WO 9514622 A1 19950601

DOCDB simple family (application)  
**DE 4340553 A 19931129**; AU 7993194 A 19941028; CA 2176921 A 19941028; EP 9403554 W 19941028; EP 94930999 A 19941028